

FEATURES:

- Typical $t_{sk(o)}$ (Output Skew) < 250ps
- ESD > 2000V per MIL-STD-883, Method 3015; > 200V using machine model (C = 200pF, R = 0)
- $V_{CC} = 3.3V \pm 0.3V$, Normal Range
- $V_{CC} = 2.7V$ to $3.6V$, Extended Range
- CMOS power levels (0.4 μ W typ. static)
- All inputs, outputs, and I/O are 5V tolerant
- Available in SSOP, TSSOP, and TVSOP packages

DRIVE FEATURES:

- Balanced Output Drivers: $\pm 12mA$ (A port)
- High Output Drivers: $\pm 24mA$ (B port)

APPLICATIONS:

- 5V and 3.3V mixed voltage systems
- Data communication and telecommunication systems

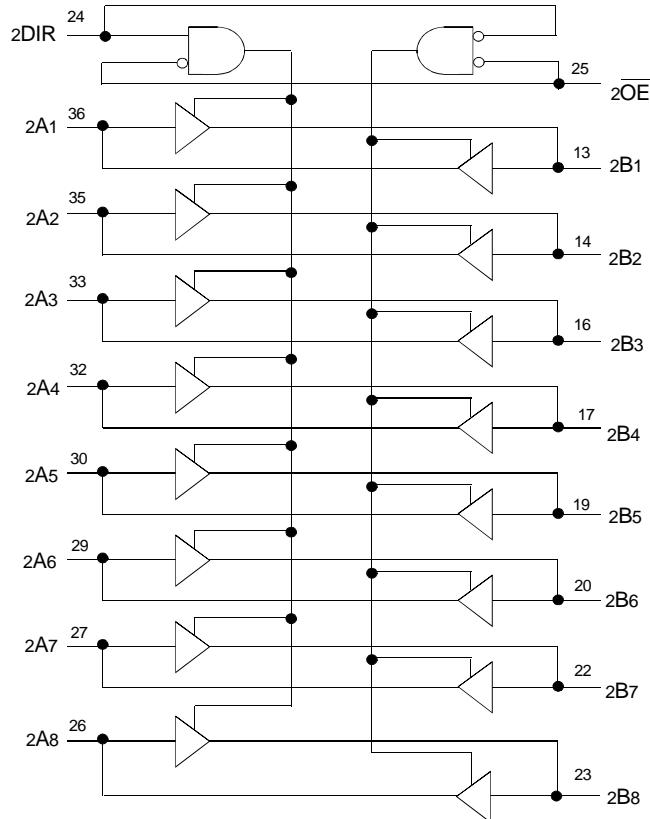
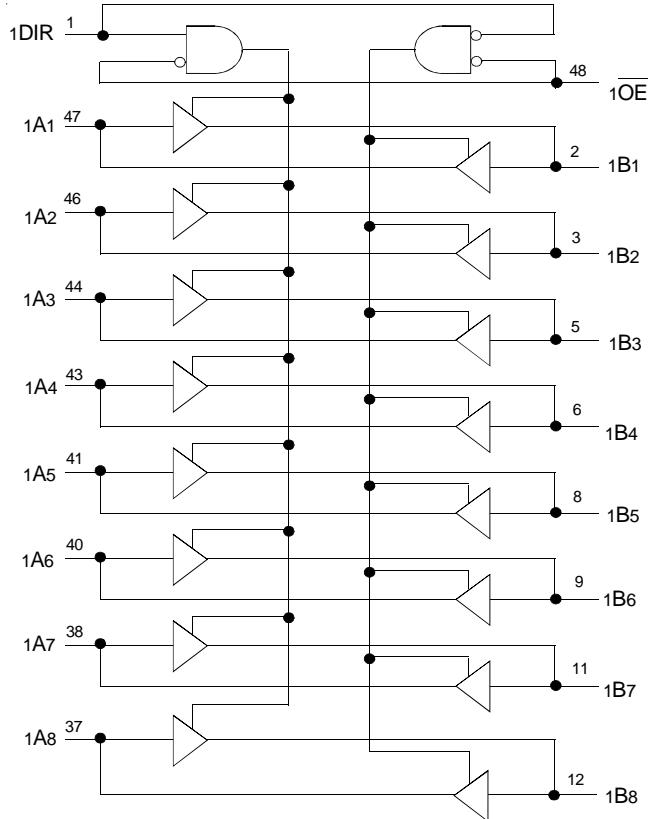
DESCRIPTION:

This 16-bit transceiver is built using advanced dual metal CMOS technology. The LVC162245A is designed for asynchronous communication between data buses. The control-function implementation minimizes external timing requirements. This device can be used as two 8-bit transceivers or one 16-bit transceiver. It allows data transmission from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable (\overline{OE}) input can be used to disable the device so that the buses are effectively isolated. To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

All pins can be driven from either 3.3V or 5V devices. This feature allows the use of this device as a translator in a mixed 3.3V/5V supply system.

The LVC162245A has series resistors in the device output structure of the "A" port which will significantly reduce line noise when used with light loads. The driver has been designed to drive $\pm 12mA$ at the designated threshold levels. The "B" port has a $\pm 24mA$ driver.

FUNCTIONAL BLOCK DIAGRAM



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INDUSTRIAL TEMPERATURE RANGE

PIN CONFIGURATION

1DIR	1	48	1 \bar{OE}
1B1	2	47	1A1
1B2	3	46	1A2
GND	4	45	GND
1B3	5	44	1A3
1B4	6	43	1A4
Vcc	7	42	Vcc
1B5	8	41	1A5
1B6	9	40	1A6
GND	10	39	GND
1B7	11	38	1A7
1B8	12	37	1A8
2B1	13	36	2A1
2B2	14	35	2A2
GND	15	34	GND
2B3	16	33	2A3
2B4	17	32	2A4
Vcc	18	31	Vcc
2B5	19	30	2A5
2B6	20	29	2A6
GND	21	28	GND
2B7	22	27	2A7
2B8	23	26	2A8
2DIR	24	25	2 \bar{OE}

SSOP/ TSSOP/ TVSOP
TOP VIEWABSOLUTE MAXIMUM RATINGS⁽¹⁾

Symbol	Description	Max	Unit
VTERM ⁽²⁾	Terminal Voltage with Respect to GND	-0.5 to +6.5	V
VTERM ⁽³⁾	Terminal Voltage with Respect to GND	-0.5 to +6.5	V
TSTG	Storage Temperature	-65 to +150	°C
I _{OUT}	DC Output Current	-50 to +50	mA
I _{IK}	Continuous Clamp Current, V _I < 0 or V _O < 0	-50	mA
I _{CC}	Continuous Current through each V _{CC} or GND	±100	mA
I _{SS}			

NOTES:

1. Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.
2. V_{CC} terminals.
3. All terminals except V_{CC}.

CAPACITANCE (T_A = +25°C, F = 1.0MHz)

Symbol	Parameter ⁽¹⁾	Conditions	Typ.	Max.	Unit
C _{IN}	Input Capacitance	V _{IN} = 0V	4.5	6	pF
C _{OUT}	Output Capacitance	V _{OUT} = 0V	6.5	8	pF
C _{I/O}	I/O Port Capacitance	V _{IN} = 0V	6.5	8	pF

NOTE:

1. As applicable to the device type.

PIN DESCRIPTION

Pin Names	Description
x \bar{OE}	Output Enable Input (Active LOW)
xDIR	Direction Control Output
xA _x	Side A Inputs or 3-State Outputs
xB _x	Side B Inputs or 3-State Outputs

FUNCTION TABLE (EACH 8-BIT SECTION)⁽¹⁾

Inputs		Outputs
x \bar{OE}	xDIR	
L	L	B Data to A Bus
L	H	A Data to B Bus
H	X	Isolation

NOTE:

1. H = HIGH Voltage Level
- X = Don't Care
- L = LOW Voltage Level

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

Following Conditions Apply Unless Otherwise Specified:

Operating Condition: $T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$

Symbol	Parameter	Test Conditions		Min.	Typ. ⁽¹⁾	Max.	Unit	
VIH	Input HIGH Voltage Level	VCC = 2.3V to 2.7V		1.7	—	—	V	
		VCC = 2.7V to 3.6V		2	—	—		
VIL	Input LOW Voltage Level	VCC = 2.3V to 2.7V		—	—	0.7	V	
		VCC = 2.7V to 3.6V		—	—	0.8		
IIH IIL	Input Leakage Current	VCC = 3.6V	VI = 0 to 5.5V	—	—	± 5	μA	
IOZH IOZL	High Impedance Output Current (3-State Output pins)	VCC = 3.6V	VO = 0 to 5.5V	—	—	± 10	μA	
IOFF	Input/Output Power Off Leakage	VCC = 0V, VIN or VO \leq 5.5V		—	—	± 50	μA	
VIK	Clamp Diode Voltage	VCC = 2.3V, IIN = -18mA		—	-0.7	-1.2	V	
VH	Input Hysteresis	VCC = 3.3V		—	100	—	mV	
IcCL IcCH IcCZ	Quiescent Power Supply Current	VCC = 3.6V		—	—	10	μA	
		VIN = GND or VCC		—	—	10		
ΔIcc		3.6 \leq VIN \leq 5.5V ⁽²⁾		—	—	500	μA	
ΔIcc		One input at VCC - 0.6V, other inputs at VCC or GND		—	—	500	μA	

NOTES:

1. Typical values are at $VCC = 3.3\text{V}$, $+25^\circ\text{C}$ ambient.

2. This applies in the disabled state only.

OUTPUT DRIVE CHARACTERISTICS (A PORT)

Symbol	Parameter	Test Conditions ⁽¹⁾		Min.	Max.	Unit
VOH	Output HIGH Voltage	VCC = 2.3V to 3.6V	IOH = -0.1mA	VCC - 0.2	—	V
		VCC = 2.3V	IOH = -4mA	1.9	—	
			IOH = -6mA	1.7	—	
		VCC = 2.7V	IOH = -4mA	2.2	—	
			IOH = -8mA	2	—	
		VCC = 3V	IOH = -6mA	2.4	—	
			IOH = -12mA	2	—	
		VCC = 2.3V to 3.6V	IOL = 0.1mA	—	0.2	V
		VCC = 2.3V	IOL = 4mA	—	0.4	
			IOL = 6mA	—	0.55	
		VCC = 2.7V	IOL = 4mA	—	0.4	
			IOL = 8mA	—	0.6	
		VCC = 3V	IOL = 6mA	—	0.55	
			IOL = 12mA	—	0.8	

NOTE:

1. VIH and VIL must be within the min. or max. range shown in the DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE table for the appropriate Vcc range. $T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$.

OUTPUT DRIVE CHARACTERISTICS (B PORT)

Symbol	Parameter	Test Conditions ⁽¹⁾		Min.	Max.	Unit
VOH	Output HIGH Voltage	VCC = 2.3V to 3.6V	IOH = - 0.1mA	VCC - 0.2	—	V
		VCC = 2.3V	IOH = - 6mA	2	—	
		VCC = 2.3V	IOH = - 12mA	1.7	—	
		VCC = 2.7V		2.2	—	
		VCC = 3V	IOH = - 24mA	2.4	—	
		VCC = 3V		2	—	
VOL	Output LOW Voltage	VCC = 2.3V to 3.6V	IOL = 0.1mA	—	0.2	V
		VCC = 2.3V	IOL = 6mA	—	0.4	
			IOL = 12mA	—	0.7	
		VCC = 2.7V	IOL = 12mA	—	0.4	
		VCC = 3V	IOL = 24mA	—	0.55	

NOTE:

1. VIH and Vil must be within the min. or max. range shown in the DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE table for the appropriate Vcc range. TA = - 40°C to + 85°C.

OPERATING CHARACTERISTICS, VCC = 3.3V ± 0.3V, TA = 25°C

Symbol	Parameter	Test Conditions	Typical	Unit
CPD	Power Dissipation Capacitance per Transceiver Outputs enabled	CL = 0pF, f = 10Mhz	—	pF
CPD	Power Dissipation Capacitance per Transceiver Outputs disabled		—	

SWITCHING CHARACTERISTICS (A PORT)⁽¹⁾

Symbol	Parameter	VCC = 2.7V		VCC = 3.3V ± 0.3V		Unit
		Min.	Max.	Min.	Max.	
tPLH	Propagation Delay xBx to xAx	1.5	5.7	1.5	4.8	ns
tPHL	Output Enable Time xOE to xAx	1.5	7.9	1.5	6.3	ns
tPZH	Output Disable Time xOE to xAx	1.5	8.3	2.2	7.4	ns
tPLZ	—	—	—	—	500	ps
tsk(o)	Output Skew ⁽²⁾	—	—	—	—	ps

NOTES:

1. See TEST CIRCUITS AND WAVEFORMS. TA = - 40°C to + 85°C.
2. Skew between any two outputs of the same package and switching in the same direction.

SWITCHING CHARACTERISTICS (B PORT)⁽¹⁾

Symbol	Parameter	VCC = 2.7V		VCC = 3.3V ± 0.3V		Unit
		Min.	Max.	Min.	Max.	
tPLH	Propagation Delay xAx to xBx	1.5	4.7	1	4	ns
tPHL	Output Enable Time xOE to xBx	1.5	6.7	1.5	5.5	ns
tPZH	Output Disable Time xOE to xBx	1.5	7.1	1.5	6.6	ns
tPLZ	—	—	—	—	500	ps
tsk(o)	Output Skew ⁽²⁾	—	—	—	—	ps

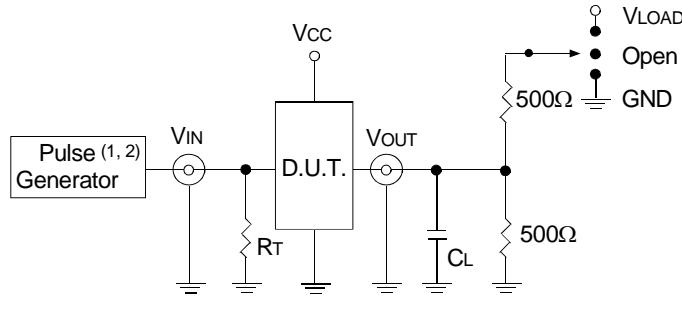
NOTES:

1. See TEST CIRCUITS AND WAVEFORMS. TA = - 40°C to + 85°C.
2. Skew between any two outputs of the same package and switching in the same direction.

TEST CIRCUITS AND WAVEFORMS

TEST CONDITIONS

Symbol	$V_{CC}^{(1)} = 3.3V \pm 0.3V$	$V_{CC}^{(1)} = 2.7V$	$V_{CC}^{(2)} = 2.5V \pm 0.2V$	Unit
V_{LOAD}	6	6	$2 \times V_{CC}$	V
V_{IH}	2.7	2.7	V_{CC}	V
V_T	1.5	1.5	$V_{CC} / 2$	V
V_{LZ}	300	300	150	mV
V_{HZ}	300	300	150	mV
C_L	50	50	30	pF



Test Circuit for All Outputs

DEFINITIONS:

C_L = Load capacitance: includes jig and probe capacitance.

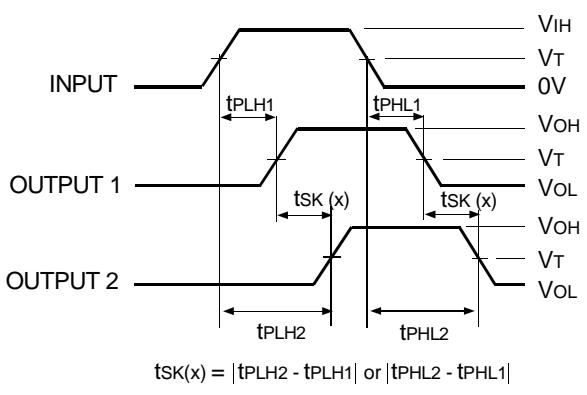
R_T = Termination resistance: should be equal to Z_{OUT} of the Pulse Generator.

NOTES:

1. Pulse Generator for All Pulses: Rate $\leq 10\text{MHz}$; $t_f \leq 2.5\text{ns}$; $t_r \leq 2.5\text{ns}$.
2. Pulse Generator for All Pulses: Rate $\leq 10\text{MHz}$; $t_f \leq 2\text{ns}$; $t_r \leq 2\text{ns}$.

SWITCH POSITION

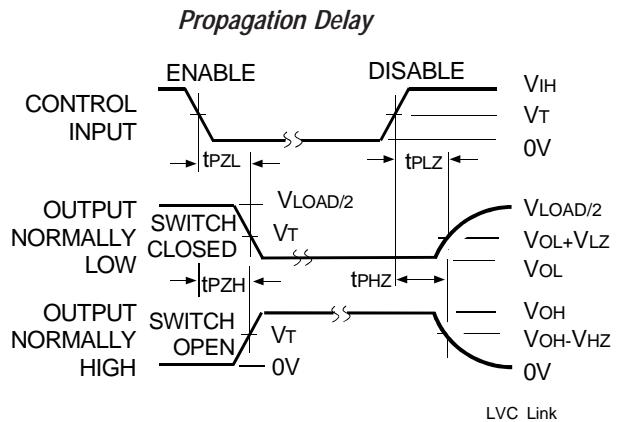
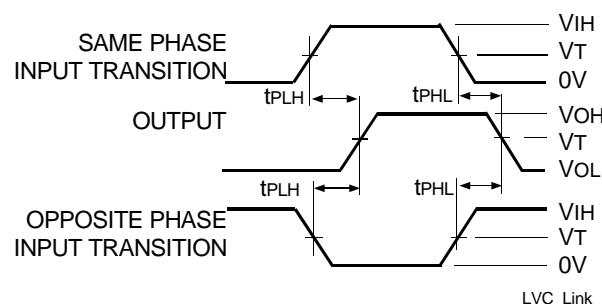
Test	Switch
Open Drain	
Disable Low	V_{LOAD}
Enable Low	
Disable High	GND
All Other Tests	Open



Output Skew - $t_{SK(x)}$

NOTES:

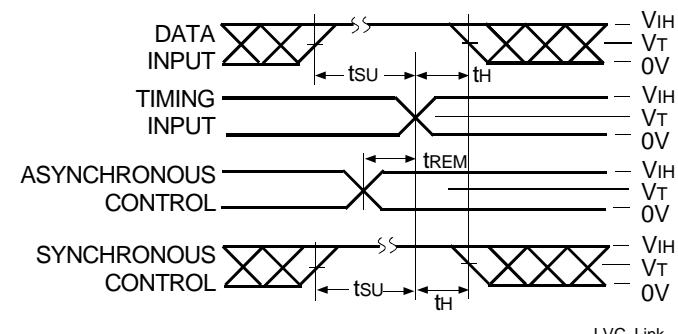
1. For $t_{SK(o)}$ OUTPUT1 and OUTPUT2 are any two outputs.
2. For $t_{SK(b)}$ OUTPUT1 and OUTPUT2 are in the same bank.



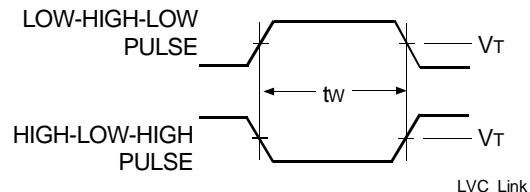
Enable and Disable Times

NOTE:

1. Diagram shown for input Control Enable-LOW and input Control Disable-HIGH.

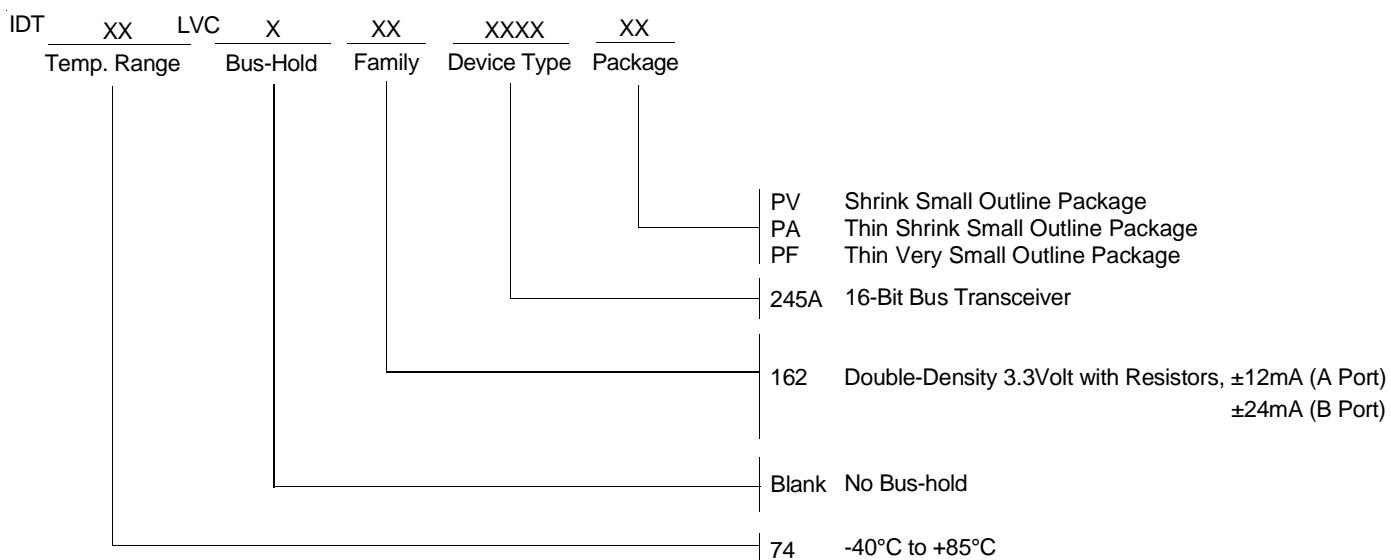


Set-up, Hold, and Release Times



Pulse Width

ORDERING INFORMATION



CORPORATE HEADQUARTERS
2975 Stender Way
Santa Clara, CA 95054

for SALES:
800-345-7015 or 408-727-6116
fax: 408-492-8674
www.idt.com

for Tech Support:
logichelp@idt.com
(408) 654-6459